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SJ

**INDUSTRY STANDARD OF THE
PEOPLE'S REPUBLIC OF CHINA**

SJ/T 11514-2015

**Thermosetting Conductive Paste for Printed Circuit Board
(PCB)**

印制电路用热固型导体浆料

(English Translation)

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What this standard covers

This Standard specifies the terms and definitions for printed circuits thermosetting conductive paste, requirements, test methods, inspection rules and packaging, labeling, transportation and so on. This Standard applies to the printed circuit board conductive pattern, contacts, contacts, jumpers, hole fill, and membrane switch, buried resistors, RFID and other manufacturing conductive paste by heat curing, including silver conductor, copper conductor paste, silver and carbon conductive carbon paste mixed slurry.

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Standards quoted by this document

GB/T 191-2008; GB/T 2036; GB/T 2421.1-2008; GB/T 2423.3-2006; GB/T 2423.16-2008; GB/T 2423.22-2002; GB/T 4677-2002; GB/T 2828.1-2003; GB/T 4588.2-1996; GB/T 5547-2007; GB/T 6739-2006; GB/T 6753.1-2007; GB/T 9286-1998; GB/T 17473.3-2008; GB/T 13557-1992; SJ/T 11171-1998